

### 8.89mmx19.05mm LED LIGHT BAR

Part Number: KB-2885SGW

Super Bright Green

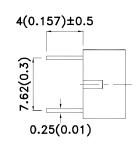
### **Features**

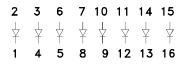
- Uniform light emitting area.
- Low current operation.
- Easily mounted on P.C. boards.
- Flush mountable.
- Excellent on/off contrast.
- Can be used with panels and legend mounts.
- RoHS compliant.

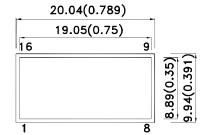
### Description

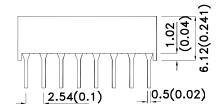
The Super Bright Green source color devices are made with Gallium Phosphide Green Light Emitting Diode.

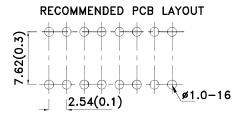
### **Package Dimensions& Internal Circuit Diagram**











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#### Notes

- 1. All dimensions are in millimeters (inches), Tolerance is ± 0.25(0.01")unless otherwise noted.
- 2. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

SPEC NO: DSAA5066 REV NO: V.7A DATE: MAY/17/2012

APPROVED: WYNEC CHECKED: Joe Lee DRAWN: C.H.Han

### **Selection Guide**

Part No.	Dice	Lens Type	lv (mcd) [1] @ 20mA	
			Min.	Тур.
KB-2885SGW	Super Bright Green (GaP)  White Diffused	White Diffused	12	32
KB-20035GW		*5	*10	

#### Notes:

- Luminous intensity/ luminous Flux: +/-15%.
   \* Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

### Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Super Bright Green	565		nm	I=20mA
λD [1]	Dominant Wavelength	Super Bright Green	568		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Super Bright Green	30		nm	I=20mA
С	Capacitance	Super Bright Green	15		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Super Bright Green	2.2	2.5	V	I=20mA
lr	Reverse Current	Super Bright Green		10	uA	V <sub>R</sub> =5V

### Notes:

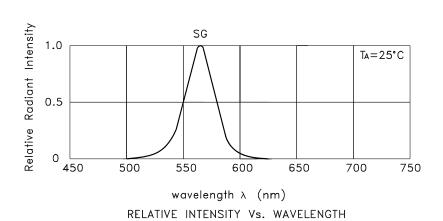
- 1.Wavelength: +/-1nm.
  2. Forward Voltage: +/-0.1V.
  3. Wavelength value is traceable to the CIE127-2007 compliant national standards.

## Absolute Maximum Ratings at TA=25°C

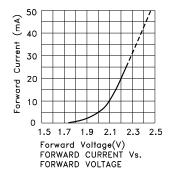
Parameter	Super Bright Green	Units
Power dissipation	62.5	mW
DC Forward Current	25	mA
Peak Forward Current [1]	140	mA
Reverse Voltage	5	V
Operating / Storage Temperature	perating / Storage Temperature -40°C To +85°C	
Lead Solder Temperature[2]	260°C For 3-5 Seconds	

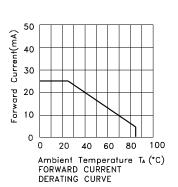
- 1. 1/10 Duty Cycle, 0.1ms Pulse Width.
   2. 2mm below package base.

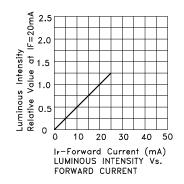
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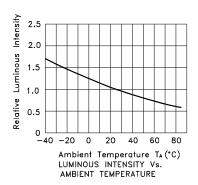


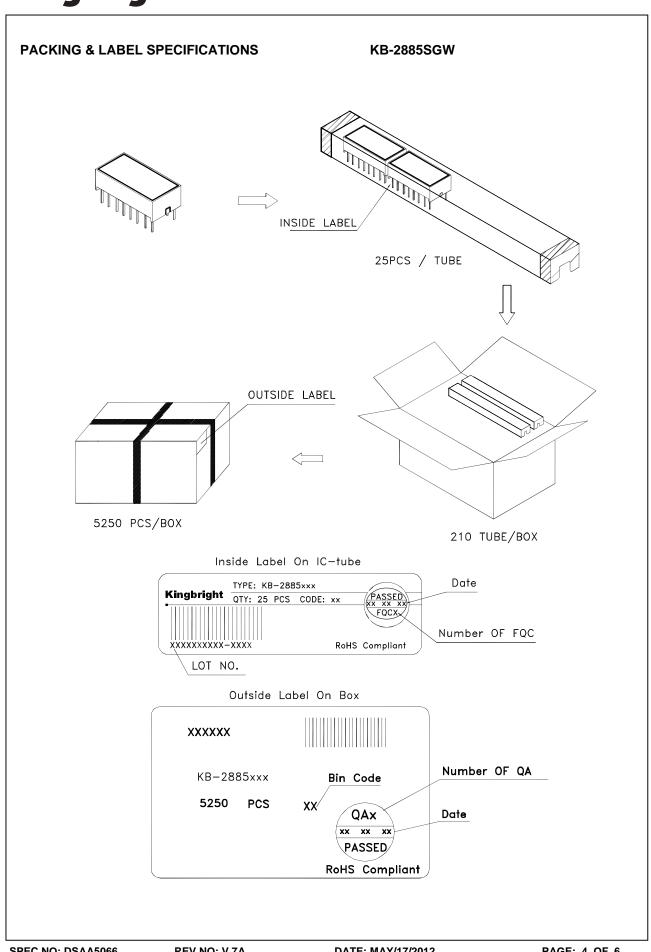
Super Bright Green KB-2885SGW











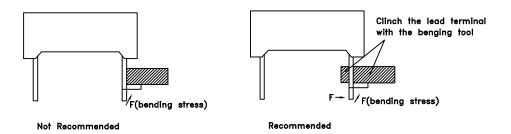
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### THROUGH HOLE DISPLAY MOUNTING METHOD

# Lead Forming

Do not bend the component leads by hand without proper tools. The leads should be bent by clinching the upper part of the lead firmly such that the bending force is not exerted on the plastic body.

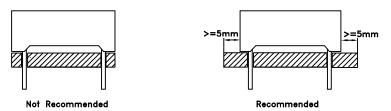


### Installation

- 1. The installation process should not apply stress to the lead terminals.
- 2. When inserting for assembly, ensure the terminal pitch matches the substrate board's hole pitch to prevent spreading or pinching the lead terminals.



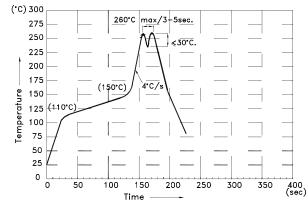
3.The component shall be placed at least 5mm from edge of PCB to avoid damage caused excessive heat during wave soldering.



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### DISPLAY SOLDERING CONDITIONS

Wave Soldering Profile For Lead-free Through-hole LED.



#### NOTES:

- 1.Recommend the wave temperature 245°C~260°C.The maximum soldering temperature should be less than 260°C.
- 2.Do not apply stress on epoxy resins when temperature is over 85°C.
- 3. The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).
- 4.During wave soldering , the PCB top—surface temperature should be kept below 105°C 5.No more than once.

### Soldering General Notes:

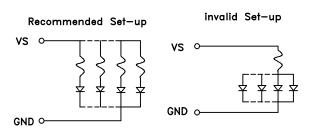
- 1. Through—hole displays are incompatible with reflow soldering.
- 2. If components will undergo multiple soldering processes, or other processes where the components may be subjected to intense heat, please check with Kingbright for compatibility.

#### **CLEANING**

- 1.Mild "no-clean" fluxes are recommended for use in soldering.
- 2. If cleaning is required, Kingbright recommends to wash components with water only. Do not use harsh organic solvents for cleaning, because they may damage the plastic parts .And the devices should not be washed for more than one minute.

### CIRCUIT DESIGN NOTES

- 1.Protective current-limiting resistors may be necessary to operate the Displays.
- 2.LEDs mounted in parallel should each be placed in series with its own current—limiting resistor.



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